

规格书编号

SPEC NO: HDFB08ARSSB5SP02

产品规格书 SPECIFICATION

CUSTOMER 客 户:					
PRODUCT 产品:	SAW FILTER				
MODEL NO 型 号:	HDFB08ARSS-B5				
MARKING 印字:	• T 5				
PREPARED 编 制:	CHECKED 审 核:				
APPROVED 批 准:	DATE日期: 2017-11-30				
客户确认 CUSTOMER RECEIVED:					
审核 CHECKED	批准 APPROVED	日期 DATE			

无锡市好达电子有限公司 Shoulder Electronics Limited



更改历史记录 History Record

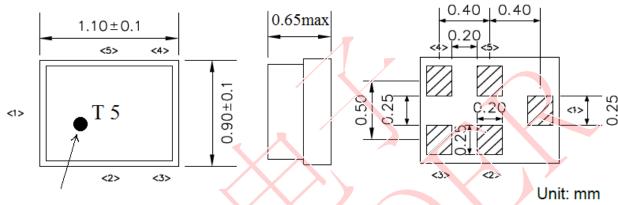
更改日期 Date	规格书编号 Spec. No.	产品型号 Part No.	客户产品型号 Customer No.	更改内容描述 Modify Content	备注 Remark
2017-5-16	SP01	HDFB08A RSS-B5		New design.	
2017-11-30	SP02	HDFB08A RSS-B5		Update the specification and increase the wideband frequency response.	6. Typical frequency response

SAW FILTER HDFB08ARSS-B5

1. Application

- Low-loss RF filter for mobile telephone GSM900 systems, receive path(RX).
- Usable passband 35MHz
- Impedance 50 ohm input and output
- Unbalanced to unbalanced operation
- RoHS compatible

2. DIMENSION (PKG SIZE 1.1 x 0.9mm)



Dot Marking

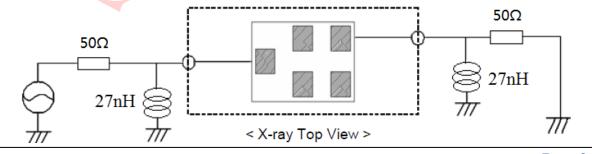
Pin configuration

- 1. Input
- 4. Output
- 2,3,5 To be grounded

3. Maximum Rating

Items	Conditions
Operation temperature rang	-30°C ~ +85°C
Storage temperature rang	-40°C ~+85°C
ESD voltage	ESD(MM): 50VDC
Sensitive discharge device	ESD(HBM): 175VDC
DC Voltage VDC	3V (25+/-2 deg.C)
Max Input Power	15dBm 2000h
Moisture Sensitivity Level	MSL 2

4. Test Circuit





SAW FILTER

5. ELECTRICAL SPECIFICATION

Table 1. Electrical Specification

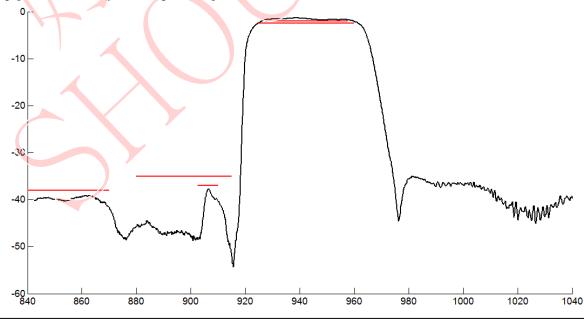
Temperature range for specification: $T = -20 \sim +80 \,^{\circ}\text{C}$

Terminating source impedance: $Zs = 50\Omega$ $Zl = 50\Omega$ Terminating load impedance:

Input power: 15dBm 2000h

mput powe	1.	1300111 2	200011			
Item		Condition	Specification		Unit	
		(MHz)	Min	Тур	Max	
Insertion 1	loss	927.4~957.6	-	1.5	2.0	dB
		925~960	-	1.8	2.5	dB
Amplitude	e Ripple	925~960	-	0.8	1.8	dB
VSWR	Input	925~960	-	1.7	2.1	-
	Output		-	1.7	2.1	-
Absolute	attenuation	45	40	60		dB
		835~870	38	40		άB
		880~915	35	45	-	dΒ
		902.5~910	37	40	-	dB
		1805~1875	39	52	-	dB
		1850~1920	38	50	-	dB
	< P	2400~2500	35	40		dB
		2685~2790	31	35	-	dB
	-/	2775~2880	31	35	1	dB
		3700~3840	30	3.5	1	dB
		4625~4800	28	33	-	dB
		5550~5760	28	33	-	dB
\ \ \ \ \ \ \		5725~5875	2.8	33	-	dB

6. Typical frequency response



-10 --20 --30 --40 --50 --60 --70 -

7. ENVIRONMENTAL CHARACTERISTICS

2000

7.1 High temperature exposure

1000

-80

Subject the device to +85°C for 16 hours. Then release the filter into the room conditions for 24 hours prior to the measurement. It shall fulfill the specifications in 5.

4000

7.2 Low temperature exposure

Subject the device to -40°C for 16 hours. Then release the device into the room conditions for 24 hours prior to the measurement. It shall fulfill the specifications in 5.

7.3 Temperature cycling

Subject the device to a low temperature of -40° C for 30 minutes. Following by a high temperature of $+85^{\circ}$ C for 30 Minutes. Then release the device into the room conditions for 24 hours prior to the measurement. It shall meet the specifications in 5.

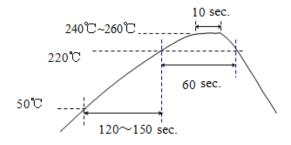
7.4 Resistance to solder heat

- 1. immerge the solder bath at 260°C for 10 sec.
- 2, the iron at 370°C for 3 sec

7.5 Solderability

Submerge the device terminals into the solder bath at 245° C $\pm 5^{\circ}$ C for 5s, More than 95% area of the soldering pad must be covered with new solder. It shall meet the specifications in 5.

7.6 Reflow soldering





SAW FILTER HDFB08ARSS-B5

The specimen shall be passed through the reflow furnace with the condition shown in the above profile for 1 time.

The specimen shall be stored at standard atmospheric conditions for 1h, after which the measurement shall be made. Test board shall be 1.6 mm thick. Base material shall be glass fabric base epoxy resin.

7.7 Mechanical shock

Drop the device randomly onto the concrete floor from the height of 1m 3 times. the device shall fulfill the specifications in 5.

7.8 Vibration

Subject the device to the vibration for 1 hour each in x,y and z axes with the amplitude of 1.5 mm at 10 to 55 Hz. The device shall fulfill the specifications in 5.

8. REMARK

8.1 Static voltage

Static voltage between signal load & ground may cause deterioration &destruction of the component. Please avoid static voltage.

8.2 Ultrasonic cleaning

Ultrasonic vibration may cause deterioration & destruction of the component. Please avoid ultrasonic cleaning

8.3 Soldering

Only pad component may be solded. Please avoid soldering another part of component.

9. Packing

9.1 Dimensions

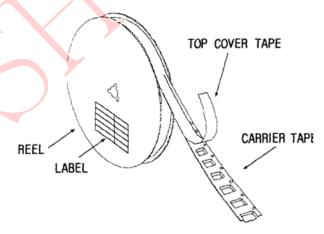
- (1) Carrier Tape: Figure 1
- (2) Reel: Figure 2
- (3) The product shall be packed properly not to be damaged during transportation and storage.

9.2 Reeling Quantity

10000 pcs/reel φ 178mm

9.3 Taping Structure

(1) The tape shall be wound around the reel in the direction shown below.



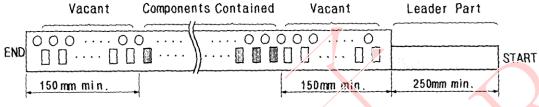
(2) Label



SAW FILTER HDFB08ARSS-B5

Device Name	
Marking	
User Product Name	
Quantity	
Lot No.	

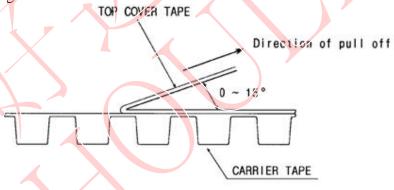
(3) Leader part and vacant position specifications.



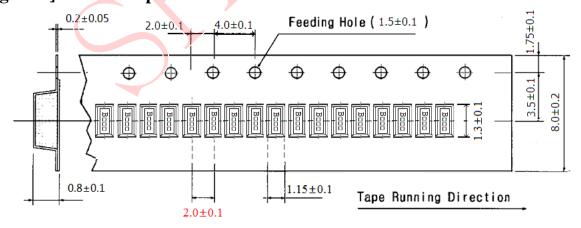
TAPE RUNNING DIRECTION

10. TAPE SPECIFICATIONS

- 10.1 Tensile Strength of Carrier Tape: 4.4N/mm width
- 10.2 Top Cover Tape Adhesion (See the below figure)
 - (1) pull off angle: 0~15°
 - (2) speed: 300mm/min.
 - (3) force: 20~70g



[Figure 1] Carrier Tape Dimensions

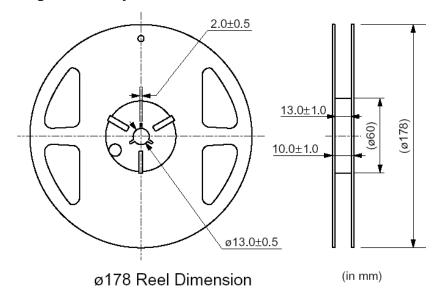


Prior to the size of 4.0 ± 0.1 , after encryption, modified to 2.0 ± 0.1 .



SAW FILTER

[Figure 2] 10000 pcs/reel ϕ 178mm



X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Signal Conditioning category:

Click to view products by SHOULDER Electronics manufacturer:

Other Similar products are found below:

MAPDCC0004 PD0409J5050S2HF 880157 HHS-109-PIN DC1417J5005AHF DC4859J5005AHF AFS14A30-2185.00-T3 AFS14A35-1591.50-T3 DS-323-PIN DSS-313-PIN B39321R801H210 B39321R821H210 B39921B4317P810 1A0220-3 2089-6207-00 JP510S LFB212G45SG8C341 LFB322G45SN1A504 LFL182G45TC3B746 SF2159E 30057 1P510S CER0813B 3A325 40287 41180 ATB3225-75032NCT B69842N5807A150 BD0810N50100AHF BD2326L50200AHF BD2425J50200AHF HMC189AMS8TR C5060J5003AHF JHS-114-PIN JP503AS DC0710J5005AHF DC2327J5005AHF DC3338J5005AHF 43020 LFB2H2G60BB1C106 LFL15869MTC1B787 X3C19F1-20S XC3500P-20S 10013-20 SF2081E SF2194E SF2238E CDBLB455KCAX39-B0 RF1353C PD0922J5050D2HF